

UNISONIC TECHNOLOGIES CO., LTD

02N50 Preliminary Power MOSFET

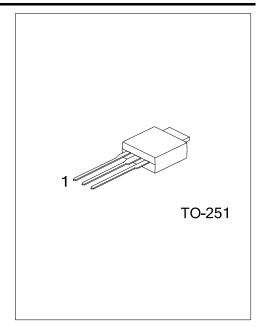
0.2A, 500V N-CHANNEL POWER MOSFET

■ DESCRIPTION

The UTC **02N50** is an N-channel MOSFET, it uses UTC's advanced technology to provide the customers with high breakdown voltage

■ FEATURES

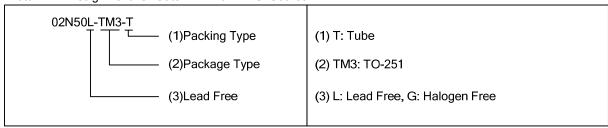
- * $R_{DS(on)}$ =75 Ω @ V_{GS} =10V, I_{D} =0.15A
- * High breakdown voltage



■ ORDERING INFORMATION

Ordering Number		Darling	Pin Assignment			Dankina	
Lead Free	Halogen Free	Package	1	2	3	Packing	
02N50L-TM3-T	02N50G-TM3-T	TO-251	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source



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■ ABSOLUTE MAXIMUM RATINGS

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	500	V	
Gate-Source Voltage		V_{GSS}	±30	V	
Drain Current	Continuous	I _D	0.2	Α	
	Pulsed	I _{DM}	1	Α	
Avalanche Current (Note 1)		I _{AR}	0.2	Α	
Power Dissipation		P_{D}	40	W	
Junction Temperature		T_J	150	°C	
Storage Temperature Range		T _{STG}	-55 ~+150	°C	

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ ELECTRICAL CHARACTERISTICS

PARAMETER		SYMBOL	TEST CONDITIONS		TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	$I_D=250\mu A, V_{GS}=0V$	500			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =500V, V _{GS} =0V, T _A =25°C			10	μA
Gate-Source Leakage Current	Forward	1	V_{GS} =+30V, V_{DS} =0V			+100	nA
	Reverse	I _{GSS}	V_{GS} =-30V, V_{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$			4.5	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =0.15A, T _A =25°C		62	75	Ω
DYNAMIC PARAMETERS							
Input Capacitance		C _{ISS}			200		pF
Output Capacitance		Coss	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		20		pF
Reverse Transfer Capacitance		C_{RSS}			8		pF
SWITCHING PARAMETERS							
Total Gate Charge		Q_G			3.0	4.5	nC
Gate to Source Charge		Q_GS	V _{GS} =10V, I _D =0.2A, V _{PS} =400V		0.45	0.7	nC
Gate to Drain Charge		Q_{GD}			0.4	0.75	nC
Turn-ON Delay Time		$t_{D(ON)}$			9		ns
Rise Time		t_R	V_{DD} =250V, I_{D} =0.2A, R_{G} =25 Ω		4		ns
Turn-OFF Delay Time		$t_{D(OFF)}$	VDD-250V, ID-0.2A, RG-2502		28		ns
Fall-Time		t _F			45		ns
SOURCE- DRAIN DIODE RATII	NGS AND C	CHARACTERI	STICS				
Maximum Body-Diode Continuous Current		I _S				0.2	Α
Maximum Body-Diode Pulsed Current		I _{SM}				1	Α
Drain-Source Diode Forward Voltage		V_{SD}	I _S =0.2A, V _{GS} =0V			1	V

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